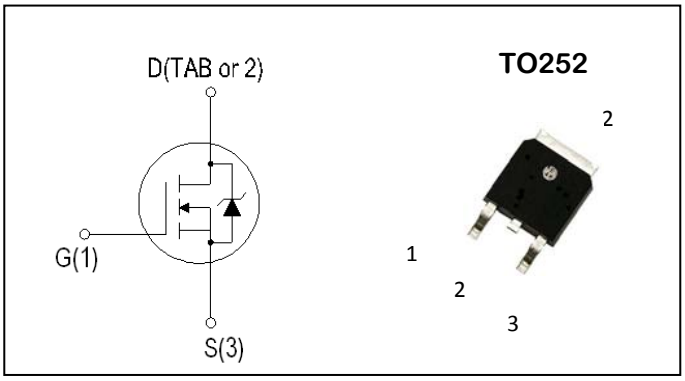
N-Channel Enhancement Mode Field Effect Transistor



PRODUCT SUMMARY

V_{DSS}	I_D	$R_{DS(ON)}$ (mΩ)
30V	90A	4.5mΩ

Absolute Maximum Ratings (T_A = 25°C unless otherwise specifed)

Symbol	Parameter		Ratings	Unit
Common Ratings				
V_{DSS}	Drain-Source Voltage		30	V
V_{GSS}	Gate-Source Voltage		±20	
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-55 to 175	°C
I_S	Diode Continuous Forward Current	TC=25°C	90	A
Mounted on Large Heat Sink				
I_{DM}	300μs Pulse Drain Current Tested(1)	T_C=25°C	360	A
I_D	Continuous Drain Current	T_C=25°C	90	A
		T_C=100°C	59	
P_D	Maximum Power Dissipation	T_C=25°C	68	W

1. Pulse width limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
R_{thJC}	Thermal resistance junction-case max	2.2	°C/W
R_{thJA}	Thermal resistance junction-ambient max	62	°C/W

Electrical Characteristics (TA=25°C Unless Otherwise Noted)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
On/off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_{DS}=250uA	30	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}= 24V, V_{GS}=0V	--	--	1	uA
		V_{DS}=24V, V_{GS}=0V T_J=55°C	--	--	5	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_{DS}=250uA	1	1.5	2.5	V
I_{GSS}	Gate Leakage Current	V_{GS}=±20V, V_{DS}=0V	--	--	±100	nA
$R_{DS(ON)}$	Drain-SourceOn-stateResistance(2)	V_{GS}= 10V, I_{DS}=30A	--	3.3	4.5	mΩ
		V_{GS}= 4.5V, I_{DS}=20A		6.7	9.5	
g_{FS}	Forward transconductance(2)	V_{DS}= 5V, I_{DS}=30A	--	47	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{GS}=0V,	--	2100	--	pF
C_{oss}	Output Capacitance	V_{DS}= 15V,	--	326	--	
C_{rss}	Reverse Transfer Capacitance	Frequency=1.0MHz	--	282	--	
Switching Characteristics						
$t_{d(ON)}$	Turn-on Delay Time(1)	V_{DD}=15V,	--	21	--	ns
t_r	Turn-on Rise Time(1)	I_D= 30A, V_{GS}= 10V,	--	32	--	
$t_{d(OFF)}$	Turn-off Delay Time(1)	R_{GEN}=3.3Ω	--	59	--	
t_f	Turn-off Fall Time(1)		--	34	--	
Q_g	Total Gate Charge(1)	V_{DS}=15V, V_{GS}= 10V,	--	45	--	nC
Q_{gs}	Gate-Source Charge(1)	I_{DS}=30A	--	3	--	
Q_{gd}	Gate-Drain Charge(1)		--	15	--	
Avalanche Characteristics						
EAS	Single Pulse Avalanche Energy (3)	L=0.5mH	95	--	--	mJ
Diode Characteristics						
V_{SD}	Diode Forward Voltage(2)	I_{SD} = 30A, V_{GS} = 0	--	--	1.2	V
t_{rr}	Reverse Recovery Time	I_{SD}=20A, dI_{SD}/dt=100A/μs	--	15	--	ns
q_{rr}	Reverse Recovery Charge		--	4	--	nC

NOTES:

1. Independent of operating temperature.
2. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%
3. The Min. value is 100% EAS tested guarantee. Limited by TJmax, IAS =19.5A, VDD = 15V, RG = 25Ω, Starting TJ = 25°C.

Typical Performance Characteristics

Figure 1: On-Region Characteristics

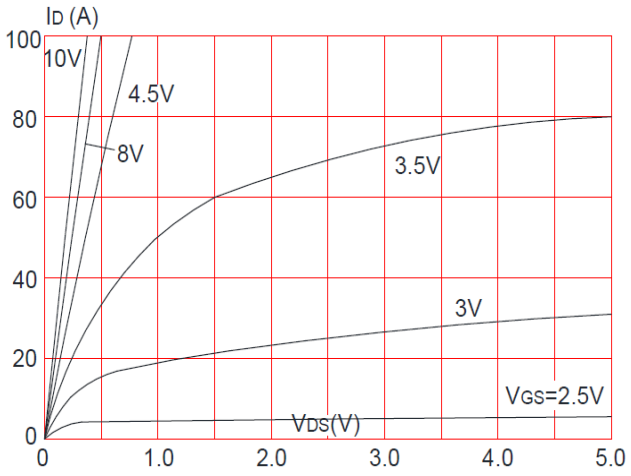


Figure 2: Transfer Characteristics

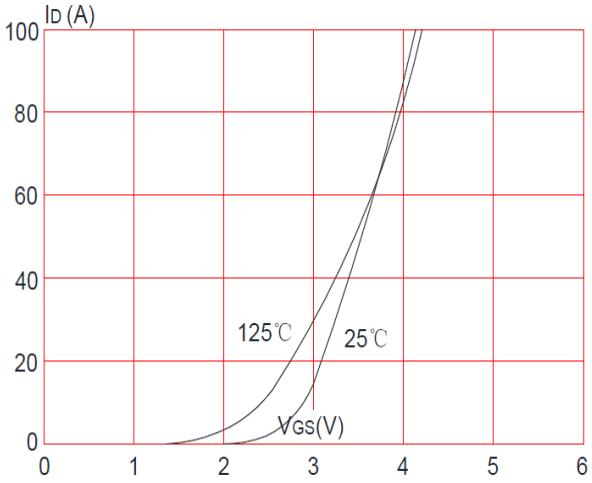


Figure 3: Rdson- Drain Current

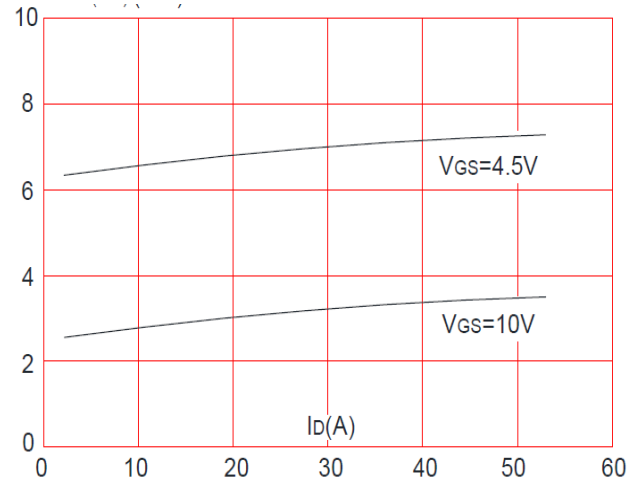


Figure 4: Normalized on Resistance vs. Junction Temperature

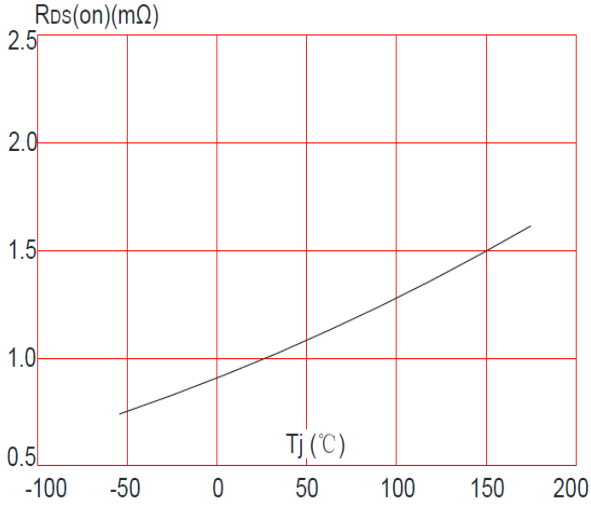


Figure 5: Source- Drain Diode Forward

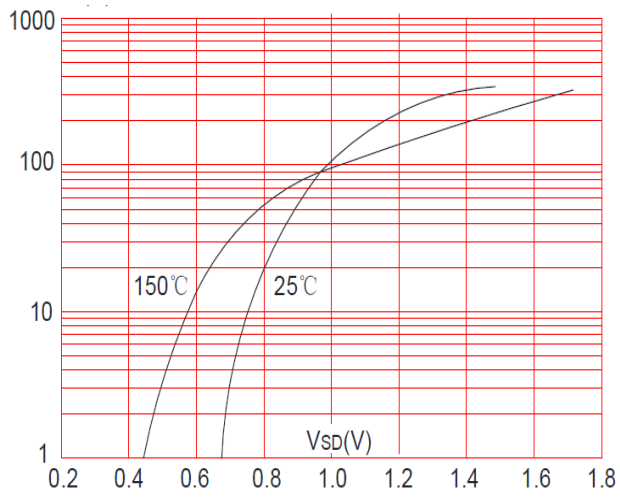


Figure 6: Gate Charge Characteristics

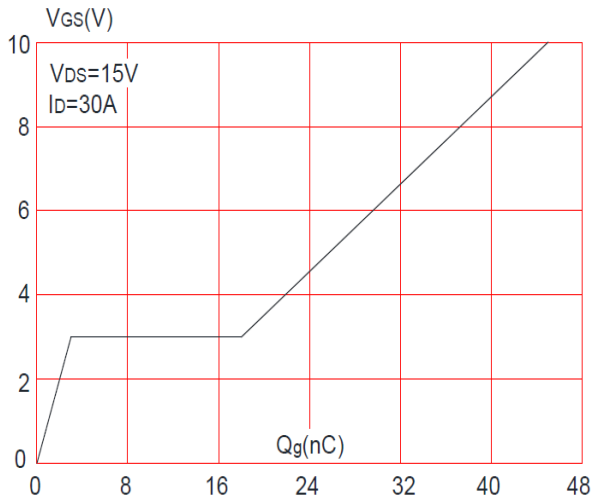


Figure 7: Capacitance vs Vds

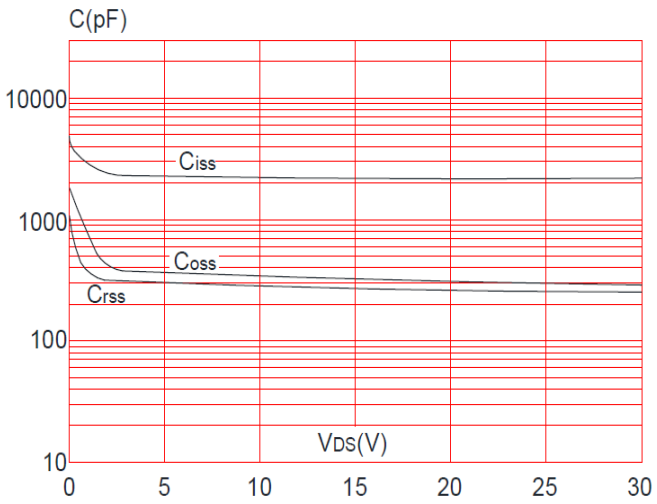


Figure 8: Safe Operation Area

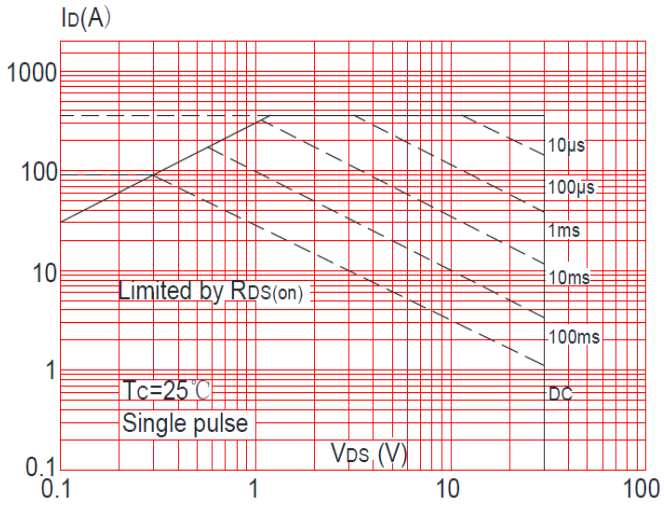


Figure 9: Maximun Drain Current vs. Case Temperature

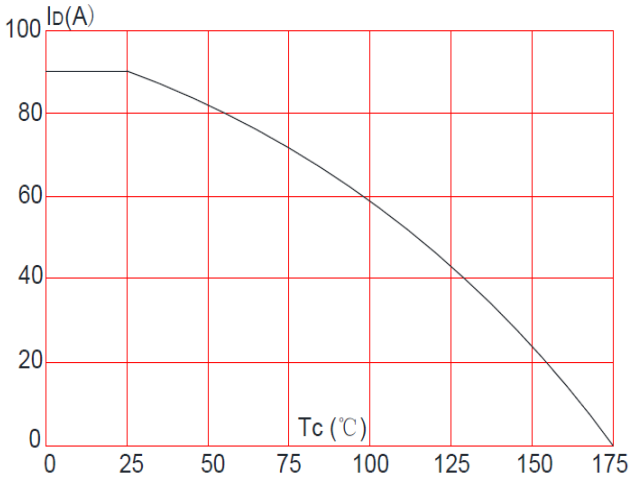


Figure 10: Normalized Breakdown Voltage vs. Junction Temperature

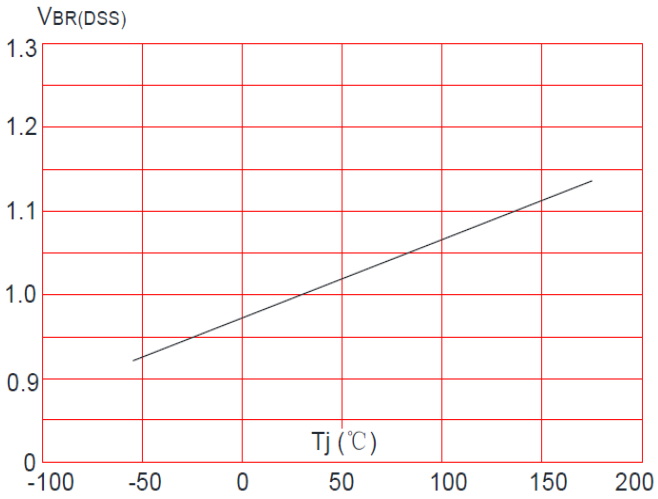
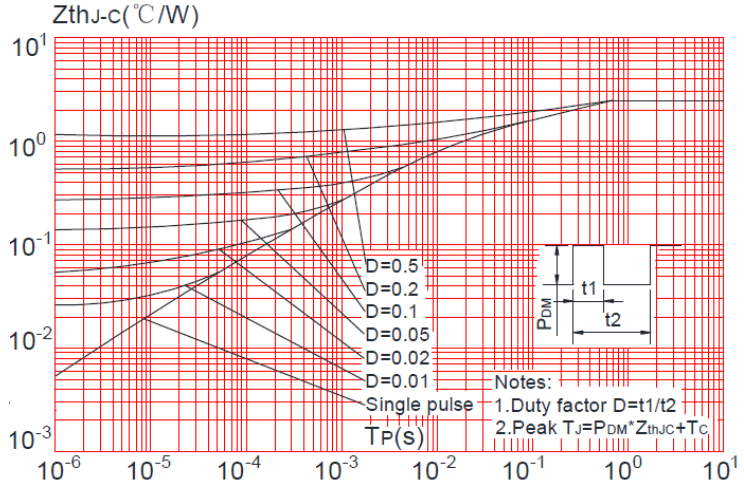
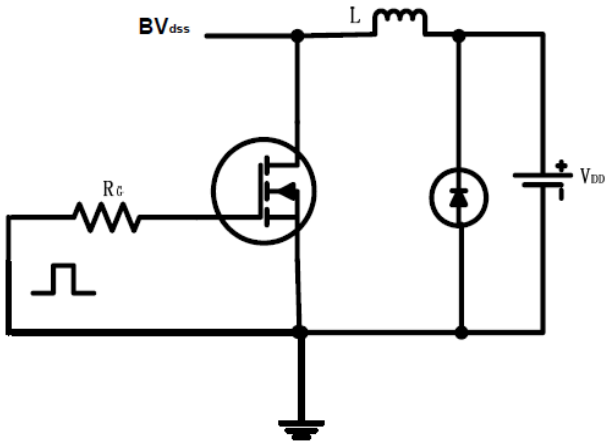


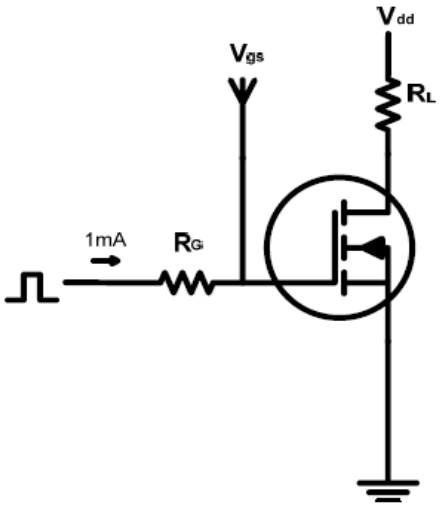
Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case



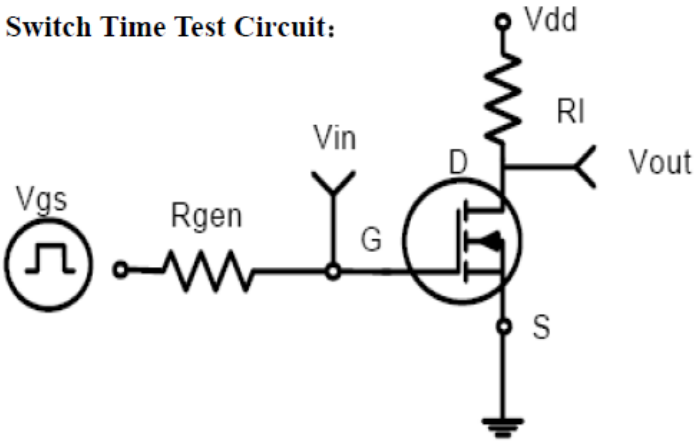
EAS test circuits:



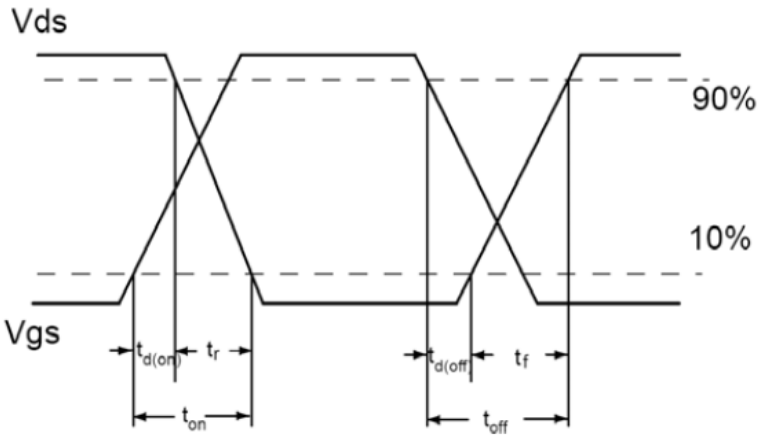
Gate charge test circuit:



Switch Time Test Circuit:

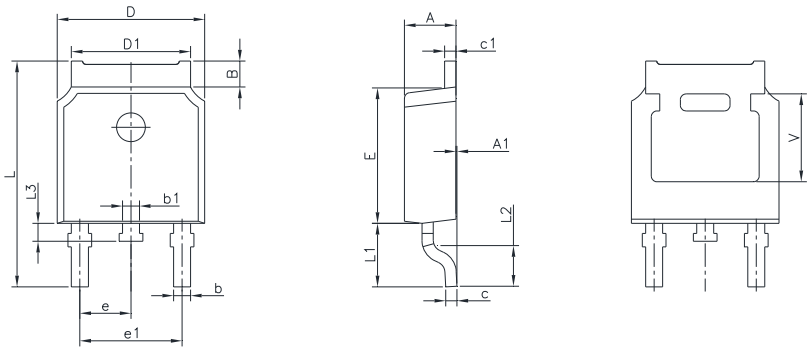


Switch Waveforms:



PACKAGE MECHANICAL DATA

TO-252-2 Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.070	1.220	0.042	0.048
b	0.720	0.850	0.028	0.033
b1	0.720	0.850	0.028	0.033
c	0.450	0.620	0.017	0.024
c1	0.450	0.620	0.017	0.024
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.900	6.200	0.232	0.244
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	10.60	0.374	0.396
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.950 REF.		0.155 REF.	

Ordering information

Part number	Package	Marking	Packing	Quantity
ADM90N03E	TO-252-2	ADM90N03E	Tube	80pcs
			Embossed tape	2500pcs

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